

har-flex Power M ang 12P SMT PL1 Sample

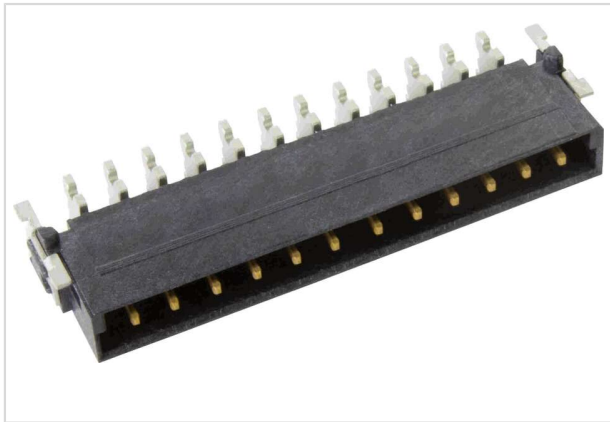


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Part number	15 55 012 2601 333
Specification	har-flex Power M ang 12P SMT PL1 Sample
HARTING eCatalogue	https://b2b.harting.com/15550122601333

Version

Termination method	Reflow soldering termination (SMT)
Connection type	Motherboard to daughtercard Extender card
Number of contacts	12
Details	According to IEC 61984, it is an unencapsulated connector. Protection against electric shock must be ensured by the type of installation by the user.
Pack contents	Sample

Technical characteristics

Contact spacing (termination side)	2.54 mm
Contact spacing (mating side)	2.54 mm
Rated current	18 A
Rated voltage	180 V
Rated voltage	acc. to IEC 60664-1
Rated impulse voltage	1.5 kV
Pollution degree	2
Clearance distance	≥1.74 mm
Creepage distance	≥1.74 mm PCB ≥1.89 mm Connector
Insulation resistance	>10 ¹⁰ Ω
Contact resistance	≤25 mΩ
Limiting temperature	-55 ... +125 °C
Performance level	1
Mating cycles	≥500



Pushing Performance
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Technical characteristics

Test voltage $U_{r.m.s.}$	1.39 kV
Isolation group	IIIa ($175 \leq CTI < 400$)
Moisture Sensitivity Level (MSL)	1 acc. to ECA/IPC/JEDEC J-STD-020D
Process Sensitivity Level (PSL)	R0 acc. to ECA/IPC/JEDEC J-STD-020D
Coplanarity of contacts	0.1 mm

Material properties

Material (insert)	Liquid crystal polymer (LCP)
Colour (insert)	Black
Material (contacts)	Copper alloy
Surface (contacts)	Noble metal over Ni Mating side Sn over Ni Termination side
Material flammability class acc. to UL 94	V-0
RoHS	compliant
ELV status	compliant
China RoHS	e
REACH Annex XVII substances	Not contained
REACH ANNEX XIV substances	Not contained
REACH SVHC substances	Not contained
California Proposition 65 substances	Not contained

Commercial data

Packaging size	1
Country of origin	China
European customs tariff number	85366990
GTIN	5713140203976
eCl@ss	27460201 PCB connector (board connector)